

ABSTRACT

In order to provide a resin sheet for sealing that has increased thermal conductivity, the present invention provides a resin sheet for sealing that includes a first filler and a second filler, said first filler being a secondary aggregate formed by aggregating thermally anisotropic boron nitride crystals, in which thermal conductivity differs depending on the direction, so as to be isotropic, wherein the thermal conductivity after thermosetting is 3 W/mK or more.